IXYS

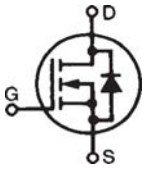
Advance Technical Information

High Voltage Power MOSFET

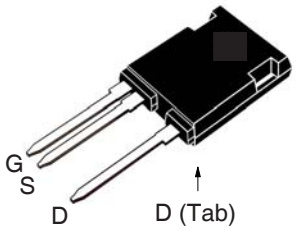
IXTX6N200P3HV

V_{DSS} = 2000V
I_{D25} = 6A
$R_{DS(on)}$ ≤ 4.0Ω

N-Channel Enhancement Mode



TO-247PLUS-HV



G = Gate D = Drain
S = Source Tab = Drain

Symbol	Test Conditions	Maximum Ratings	
V_{DSS}	T_J = 25°C to 150°C	2000	V
V_{DGR}	T_J = 25°C to 150°C, R_{GS} = 1MΩ	2000	V
V_{GSS}	Continuous	±20	V
V_{GSM}	Transient	±30	V
I_{D25}	T_C = 25°C	6	A
I_{DM}	T_C = 25°C, Pulse Width Limited by T_{JM}	18	A
P_D	T_C = 25°C	960	W
T_J		- 55 ... +150	°C
T_{JM}		150	°C
T_{stg}		- 55 ... +150	°C
T_L	Maximum Lead Temperature for Soldering	300	°C
T_{SOLD}	1.6 mm (0.062in.) from Case for 10s	260	°C
M_d	Mounting Force	20..120 / 4.5..27	Nm/lb.in
Weight		6	g

Features

- High Blocking Voltage
- High Voltage Package

Advantages

- Easy to Mount
- Space Savings
- High Power Density

Applications

- High Voltage Power Supplies
- Capacitor Discharge Applications
- Pulse Circuits
- Laser and X-Ray Generation Systems

Symbol	Test Conditions (T_J = 25°C, Unless Otherwise Specified)	Characteristic Values Min.	Typ.	Max.	
BV_{DSS}	V_{GS} = 0V, I_D = 250μA	2000			V
$V_{GS(th)}$	V_{DS} = V_{GS}, I_D = 250μA	3.0		5.0	V
I_{GSS}	V_{GS} = ±20V, V_{DS} = 0V			±100	nA
I_{DSS}	V_{DS} = 0.8 • V_{DSS}, V_{GS} = 0V			25	μA
	T_J = 100°C		150		μA
$R_{DS(on)}$	V_{GS} = 10V, I_D = 3A, Note 1			4.0	Ω

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Symbol	Test Conditions (T_J = 25°C, Unless Otherwise Specified)	Characteristic Values Min.	Typ.	Max.	
g_{fs}	V_{DS} = 30V, I_D = 3A, Note 1	4.5	7.5		S
C_{iss}	V_{GS} = 0V, V_{DS} = 25V, f = 1MHz		3700		pF
C_{oss}			236		pF
C_{rss}			104		pF
R_{Gi}	Gate Input Resistance		2.5		Ω
$t_{d(on)}$	**Resistive Switching Times**		28		ns
t_r	V_{GS} = 10V, V_{DS} = 500V, I_D = 0.5 • I_{D25}		22		ns
$t_{d(off)}$	R_G = 2Ω (External)		80		ns
t_f			46		ns
$Q_{g(on)}$	V_{GS} = 10V, V_{DS} = 0.5 • V_{DSS}, I_D = 0.5 • I_{D25}		143		nC
Q_{gs}			21		nC
Q_{gd}			70		nC
R_{thJC}				0.13	°C/W
R_{thCS}			0.15		°C/W

Source-Drain Diode

Symbol	Test Conditions (T_J = 25°C, Unless Otherwise Specified)	Characteristic Values Min.	Typ.	Max	
I_S	V_{GS} = 0V, Note1			6	A
I_{SM}	Repetitive, pulse Width Limited by T_{JM}			24	A
V_{SD}	I_F = I_S, V_{GS} = 0V, Note 1			1.5	V
t_{rr}	I_F = 3A, -di/dt = 100A/μs		520		ns
Q_{RM}	V_R = 100V		580		nC
I_{RM}			2.2		A

Note: 1. Pulse test, t ≤ 300μs, duty cycle, d ≤ 2%.

ADVANCE TECHNICAL INFORMATION

The product presented herein is under development. The Technical Specifications offered are derived from a subjective evaluation of the design, based upon prior knowledge and experience, and constitute a "considered reflection" of the anticipated result. IXYS reserves the right to change limits, test conditions, and dimensions without notice.

IXYS Reserves the Right to Change Limits, Test Conditions, and Dimensions.

IXYS MOSFETs and IGBTs are covered by one or moreof the following U.S. patents: 4,835,592 4,860,072 4,881,106 4,931,844 5,017,508 5,034,796 5,049,961 5,063,307 5,187,117 5,237,481 5,381,025 5,486,715 6,162,665 6,259,123 B1 6,306,728 B1 6,404,065 B1 6,534,343 6,583,505 6,683,344 6,710,405 B2 6,710,463 6,727,585 6,759,692 6,771,478 B2 7,005,734 B2 7,063,975 B2 7,071,537 7,157,338B2

Fig. 1. Output Characteristics @ T_J = 25ºC

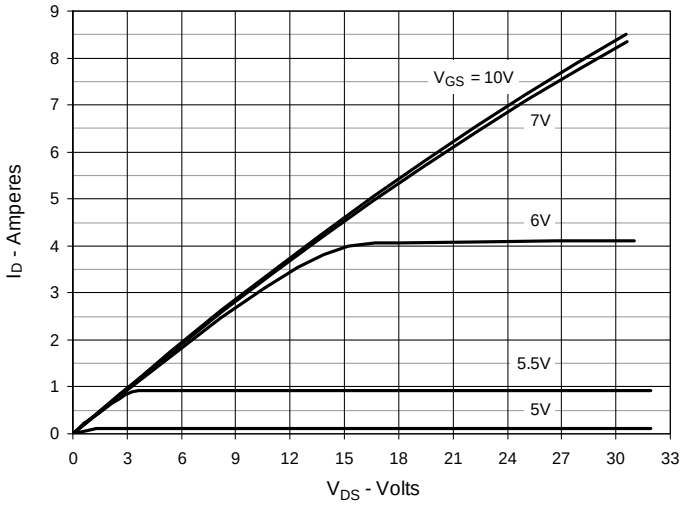

Fig. 2. Output Characteristics @ T_J = 125ºC

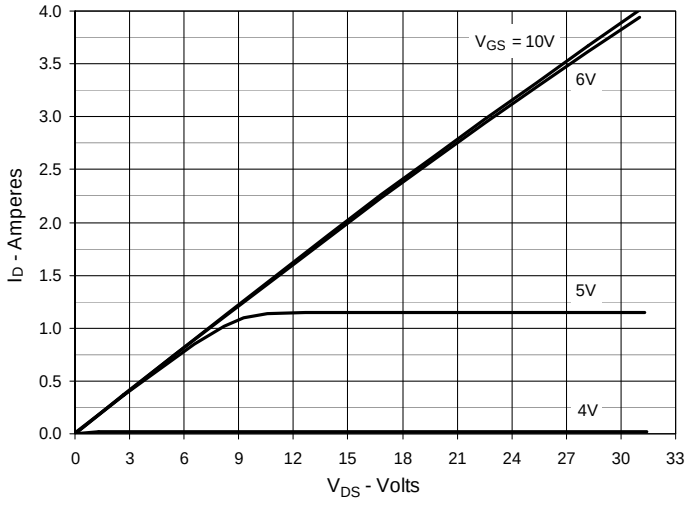

Fig. 3. $R_{DS(on)}$ Normalized to I_D = 3A Value vs. Junction Temperature

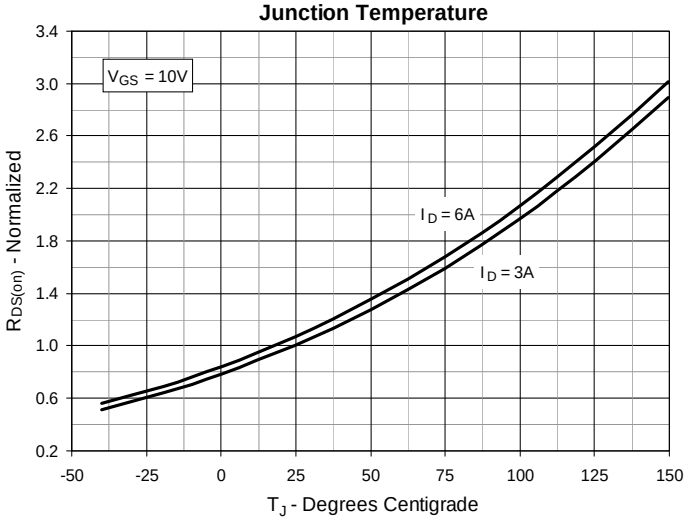

Fig. 4. $R_{DS(on)}$ Normalized to I_D = 3A Value vs. Drain Current

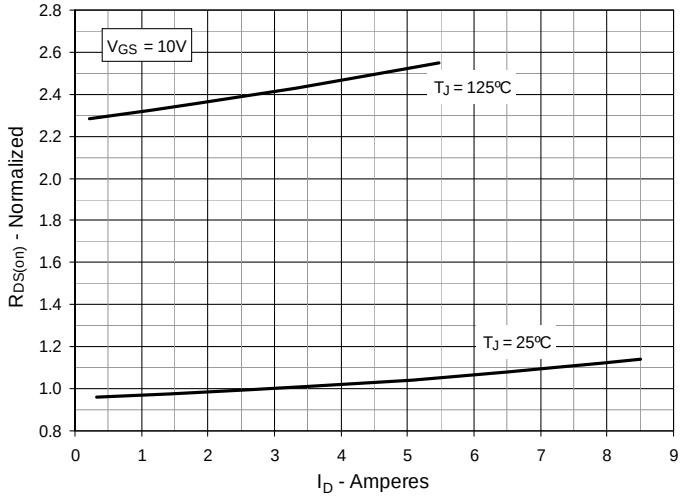

Fig. 5. Maximum Drain Current vs. Case Temperature

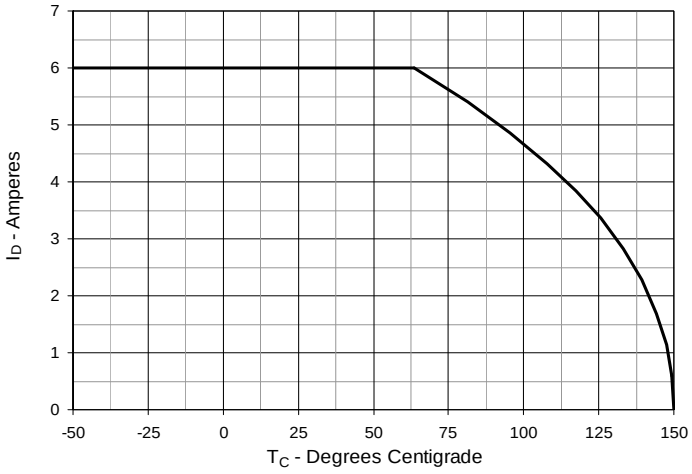

Fig. 6. Input Admittance

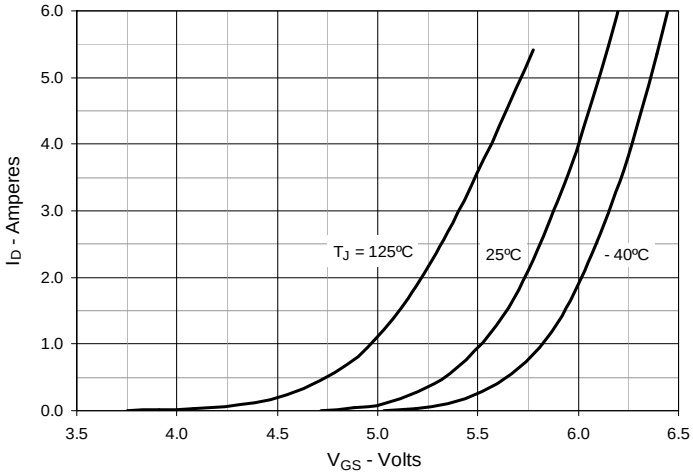

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Fig. 7. Transconductance

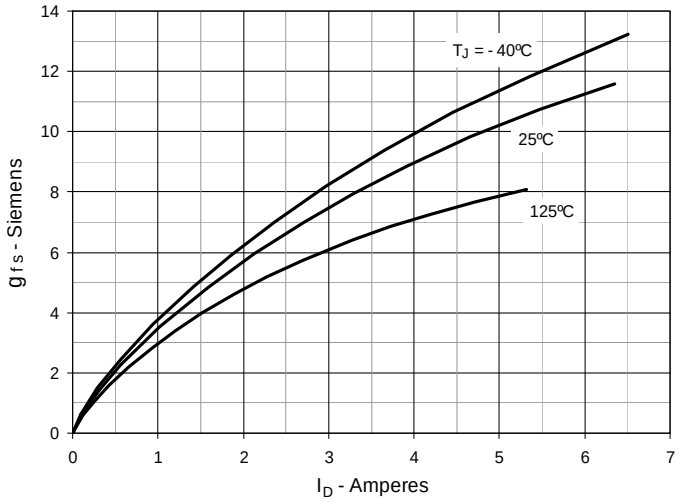


Fig. 8. Forward Voltage Drop of Intrinsic Diode

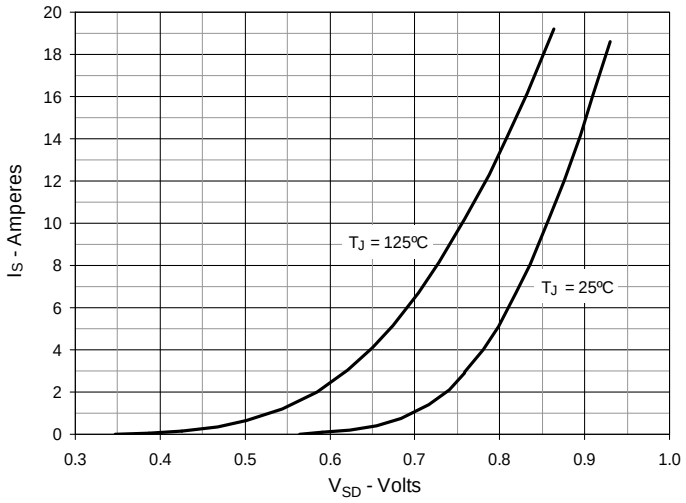


Fig. 9. Gate Charge

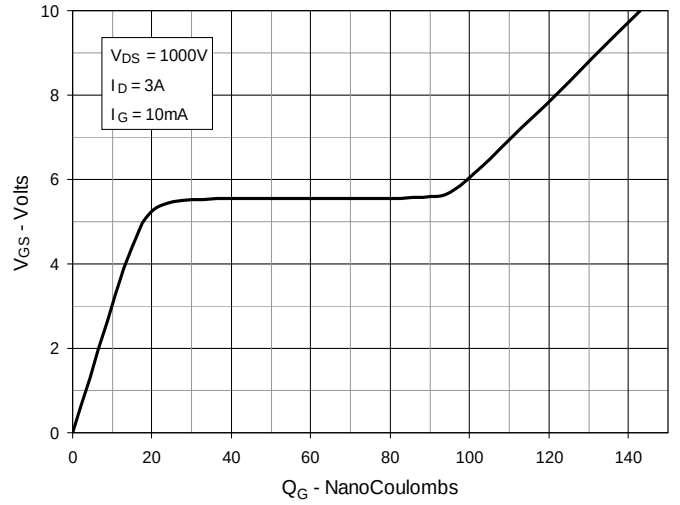


Fig. 10. Capacitance

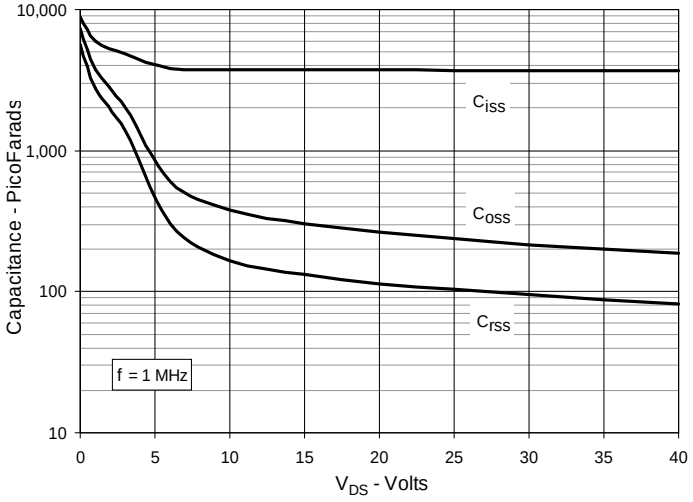


Fig. 11. Forward-Bias Safe Operating Area

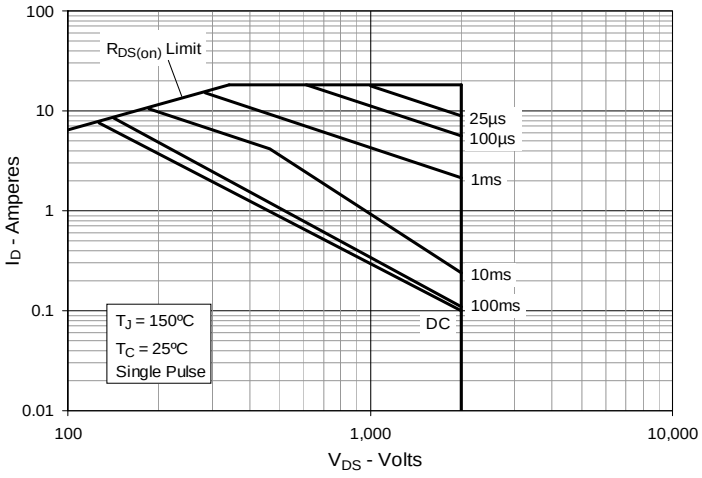
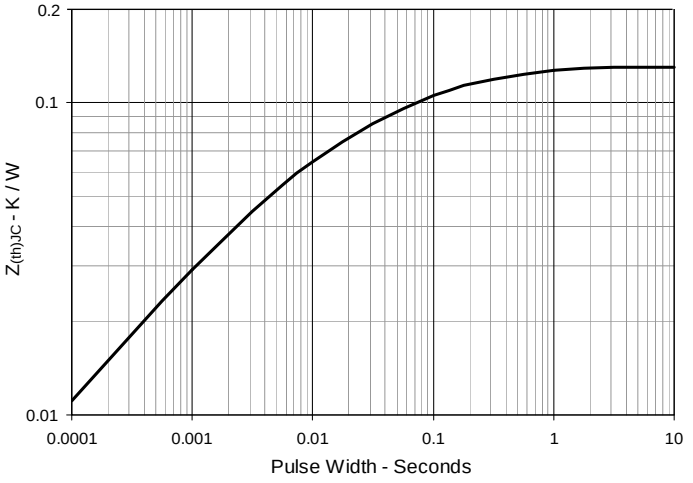


Fig. 12 Maximum Transient Thermal Impedance



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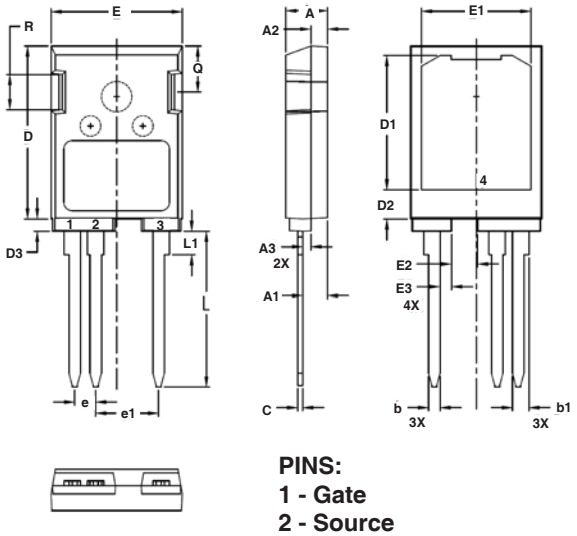
TO-247PLUS HV OUTLINE



PINS:
1 - Gate
2 - Source
3,4 - Drain

SYM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	.193	.201	4.90	5.10
A1	.114	.122	2.90	3.10
A2	.075	.083	1.90	2.10
A3	.035	.043	0.90	1.10
b	.053	.059	1.35	1.50
b1	.075	.083	1.90	2.10
c	.022	.030	0.55	0.75
D	.819	.843	20.80	21.40
D1	.638	.646	16.20	16.40
D2	.134	.146	3.40	3.70
D3	.055	.063	1.40	1.60
E	.622	.638	15.80	16.20
E1	.520	.528	13.20	13.40
E2	.118	.126	3.00	3.20
E3	.051	.059	1.30	1.50
e	.100 BSC		2.54 BSC	
e1	.300 BSC		7.62 BSC	
L	.732	.748	18.60	19.00
L1	.106	.118	2.70	3.00
Q	.216	.224	5.50	5.70
R	.165	.169	4.20	4.30

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